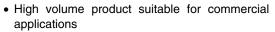




Lead (Pb)-free Commodity Thick Film Chip Resistors



FEATURES





- Pure tin solder contacts on Ni barrier layer provides compatibility with lead (Pb)-free and lead containing soldering processes
- · Metal glaze on high quality ceramic
- Compliant to RoHS Directive 2002/95/EC
- Halogen-free according to IEC 61249-2-21 definition

STANDARD ELECTRICAL SPECIFICATIONS								
	SIZE		RATED	LIMITING	TEMPERATURE		RESISTANCE	
MODEL	INCH	METRIC	DISSIPATION P _{70 °C} W	VOLTAGE Umax. AC/DC	COEFFICIENT ppm/K	TOLERANCE %	RANGE Ω	SERIES
CRCW0201	0201	RR 0603M	0.05		± 100	± 1	47R to 1M0	E24; E96
				30	± 200	± 1 ± 5	10R to 1M0	E24; E96 E24
			Zero-Ohm-Resistor: $R_{\text{max}} = 50 \text{ m}\Omega$, $I_{\text{max.}}$ at 70 °C = 1.0 A					

Notes

- These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over
 operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.
- · Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.

TECHNICAL SPECIFICATIONS					
PARAMETER	UNIT	CRCW0201			
Rated dissipation P_{70} ⁽¹⁾	W	0.05			
Limiting element voltage $U_{\rm max.}$ AC/DC	V	30			
Insulation voltage U_{ins} (1 min)	V	50			
Insulation resistance	Ω	> 109			
Category temperature range	°C	- 55 to + 155			
Weight	mg	0.17			

Note

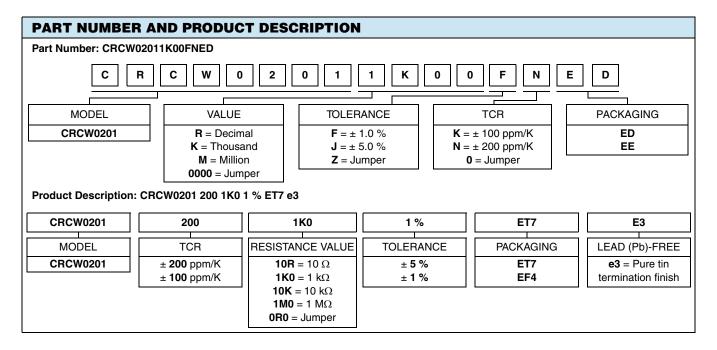
(1) The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded.

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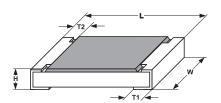
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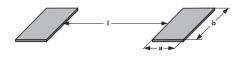




PACKAGING						
MODEL	UNIT	PAPER TAPE ON REEL ACC. TO IEC 60286-3, TYPE I				
		QUANTITY	PART NUMBER	PRODUCT DESC.		
CDCW0201	180 mm/7"	10 000	ED	ET7		
CRCW0201	330 mm/13"	50 000	EE	EF4		

DIMENSIONS in millimeters





SIZE		DIMENSIONS					SOLDER PAD DIMENSIONS		
SIZE		DIMENSIONS					REFLOW SOLDERING		
INCH	METRIC	L	W	Н	T1	T2	а	b	I
0201	0603	0.6 ± 0.05	0.3 ± 0.05	0.23 ± 0.05	0.15 ± 0.05	0.15 + 0.05 - 0.10	0.28	0.43	0.23

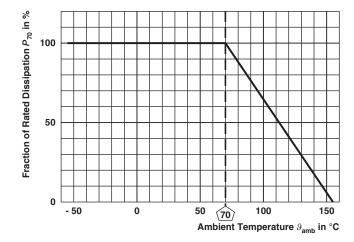
Note

· No marking for 0201 size



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DERATING



TEST F	TEST PROCEDURES AND REQUIREMENTS							
EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (Δ <i>R</i>)				
			Stability for product types:					
			CRCW0201 e3	10 Ω to 1 M Ω				
4.5	-	Resistance	-	± 1 %; ± 5 %				
4.7	-	Voltage proof	$U = 1.4 \times U_{ins}$; 60 s	No flashover or breakdown				
4.13	-	Short time overload	$U = 2.5 \times \sqrt{P_{70} \times R}$ $\leq 2 \times U_{\text{max}};$ duration: 0.5 s	± (1 % <i>R</i> + 0.05 Ω)				
4.17.0		Coldorability	Solder bath method; Sn60Pb40 non activated flux; (235 ± 5) °C (2 ± 0.2) s	Good tinning (≥ 95 % covered) no visible damage				
4.17.2 58 (*	58 (Td)	Solderability	Solder bath method; Sn96.5Ag3Cu0.5 non-activated flux; (245 ± 5) °C (3 ± 0.3) s	Good tinning (≥ 95 % covered) no visible damage				
4.8.4.2	-	Temperature coefficient	(20/- 55/20) °C and (20/125/20) °C	± 100 ppm/K, ± 200 ppm/K				
4.32	21 (Uu ₃)	Shear (adhesion)	9 N	No visible damage				
4.33	21 (Uu ₁)	Substrate bending	Depth 2 mm; 3 times	No visible damage, no open circuit in bent position $\pm (0.5~\%~R + 0.05~\Omega)$				
4.19	14 (Na)	Rapid change of	30 min. at - 55 °C; 30 min. at 125 °C					
7.10	17 (Να)	temperature	5 cycles	$\pm (0.5 \% R + 0.05 \Omega)$				
			1000 cycles	± (1 % R + 0.05 Ω)				

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TEST F	TEST PROCEDURES AND REQUIREMENTS							
EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (Δ <i>R</i>)				
	'		Stability for product types:					
			CRCW0201 e3	10 Ω to 1 M Ω				
4.23	-	Climatic sequence:	-					
4.23.2	2 (Ba)	Dry heat	125 °C; 16 h					
4.23.3	30 (Db)	Damp heat, cyclic	55 °C; ≥ 90 % RH; 24 h; 1 cycle					
4.23.4	1 (Aa)	Cold	- 55 °C; 2 h	± (2 % R + 0.1 Ω)				
4.23.5	13 (M)	Low air pressure	1 kPa; (25 ± 10) °C; 1 h					
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; ≥ 90 % RH; 24 h; 5 cycles					
4.23.7	-	DC load	$U = \sqrt{P_{70} \times R}$					
4.25.1		Endurance at 70 °C	$U = \sqrt{P_{70} \times R} \le U_{\text{max}};$ 1.5 h on; 0.5 h off;					
4.25.1	-		70 °C; 1000 h	± (2 % R + 0.1 Ω)				
			70 °C; 8000 h	± (4 % R + 0.1 Ω)				
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method (260 ± 5) °C; (10 ± 1) s	± (1 % R + 0.05 Ω)				
4.35	-	Flamability, needle flame test	IEC 60695-11-5; 10 s	No burning after 30 s				
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; (93 ± 3) % RH; 56 days	± (2 % R + 0.1 Ω)				
4.25.3	-	Endurance at upper category temperature	155 °C, 1000 h	± (2 % R + 0.1 Ω)				
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2	No visible damage				
4.22	6 (Fc)	Vibration, endurance by sweeping	$f = 10 \text{ Hz to } 2000 \text{ Hz}; \\ x, y, z \le 1.5 \text{ mm}; \\ A \le 200 \text{ m/s}^2; \\ 10 \text{ sweeps per axis}$	± (0.5 % R + 0.05 Ω)				

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2-x, environmental test procedures

Packaging of components is done in paper tapes according to IEC 60286-3.

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